

# □ MN103S33N

<b>Type</b>	MN103S33N (under development)	
<b>Command ROM (×64-bit)</b>	512 K-byte	
<b>Data RAM (×32-bit)</b>	24 K-byte	
<b>Package</b>	MLGA344-C-1313 *Lead-free	
<b>Minimum Instruction Execution Time</b>	24.3 ns (at 2.3 V to 2.7 V, 41 MHz)	
<b>Interrupts</b>	<ul style="list-style-type: none"> <li>• RESET • IRQ × 15 • NMI • Key input • Timer × 44 • Input capture × 16 • PWM × 8 • SIF × 25</li> <li>• DMA × 12 • WDT • A/D • System error</li> </ul>	
<b>Timer Counter</b>	<p>8-bit timer × 12</p> <p style="padding-left: 20px;">Reload-down count</p> <p style="padding-left: 20px;">Cascade connection possible (usable as a 16-bit to 32-bit timer)</p> <p>8-bit timer with PWM × 8</p> <p style="padding-left: 20px;">Reload-down count</p> <p style="padding-left: 20px;">Cascade connection possible (usable as a 16-bit to 32-bit timer)</p> <p style="padding-left: 20px;">PWM generating function</p> <p>16-bit timer × 6</p> <p style="padding-left: 20px;">Up-down count</p> <p style="padding-left: 20px;">Input capture function</p> <p style="padding-left: 20px;">PWM generating function</p> <p style="padding-left: 20px;">Compare/capture register 2-ch.</p> <p>16-bit timer × 6</p> <p style="padding-left: 20px;">Reload-down count</p> <p>Watchdog timer × 1</p>	
<b>DMA Controller</b>	<p>Number of channels: 4</p> <p>Unit of transfer: 8/16/32 bits</p> <p>Max. Transfer cycles: 65535</p> <p>Starting factor: external interrupt, timer factor, PWM factor, serial transmission/reception factor, A/D conversion finish, software factor</p> <p>Transfer method: 2-bus cycle transfer</p> <p>Addressing modes: fixed, increment, decrement</p> <p>Transfer modes: word transfer, burst transfer, intermittent transfer</p>	
<b>Serial Interface</b>	<p>Serial 0, 1, 3 to 8, A, B: start-stop synchronization/synchronization/I<sup>2</sup>C commonly used, 10 lines</p> <p>Serial 2, 9: 2 lines for start-stop synchronization only, serial 2: 10 bytes containing receive FIFO</p>	
<b>I/O Pins</b>	<b>I/O</b>	169 • Common use
	<b>Input</b>	25 • Common use
<b>A/D Inputs</b>	10-bit × 25-ch.	
<b>PWM</b>	12-, 14-bit resolution × 5-ch. output waveform value load control function provided 16-bit resolution × 2-ch.	
<b>ICR</b>	28-bit × 13-ch. + 16-bit × 6-ch. (common with timer)	
<b>OCR</b>	16-bit × 12-ch. (common with timer)	
<b>Timer Synchronous Output</b>	4-bit (synchronous output) × 2-ch.	

Electrical Characteristics T.B.D.

Pin Assignment

Perspective

		TDI	PF3, TM25IOB	PF1, TM24IOB	VDD2	PD5, TM15IO	PD2, TM12IO	PC6, SY1OT2, SBT8	PC4, SY1OT0, SB18	VSS	PB2, IRQ14	PA2, SBT6	P91, ICR9	P87, ICR7	P83, ICR3	P81, ICR1			
N.D.		TCK	PF2, TM25IOA	PE0, TM20IOA	PE5, TM22IOB	PE3, TM21IOB	PD3, TM13IO	VDD2	PC2, SY0OT2	PB4, SBO7	PA4, SBO7	PA0, SBI6	VSS	P85, ICR5	P60, ICR8	P80, ICR0	N.D.		
TDO	PV2, SBTA	PV1, SBOA	PE6, TM23IOA	PE2, TM21IOA	PD4, TM14IO	PD1, TM11IO	PC7, SY1OT3	PC1, SY0OT1	PB5, BG	PB1, IRQ13	PA5, SBT7	PA3, SBI7	P92, ICR10	P86, ICR6	VSS	P62, ICR10	P63, IRQ11	P61, IRQ9	
PV0, SBIA	PG6, AN6	VREFL	TMS	PF0, TM24IOA	PE4, TM22IOA	PE7, TM23IOB	PE1, TM20IOB	PD0, TM10IO	PC0, SY0OT0	PB0, SBO6	P93, ICR11	P94, ICR12	VDD2	P82, ICR2	P84, ICR4	P54, ICR4	P33, D27, SBT2	N.C.*2 (VDDF)	
PV3, ADTRG	VSS	PG2, AN2	VDD	TRST	N.D.	VDD	N.C.*1 (VSS)	VSS	PC5, SY1OT1, SBO8	PC3, SY0OT3	PB3, WDOVF	PA1, SBO6	N.C.*1 (VSS)	P90, ICR8	P56, IRQ6	P34, D28, SBI3	P25, D21, SBT1	P57, IRQ7	
PG3, AN3	AVDD	PG4, AN4	VREFH	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P52, IRQ2	P43, PWM4	P53, IRQ3	P51, IRQ1	
PG7, AN7	PG5, AN5	PH2, AN10	PG1, AN1	PG0, AN0	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P50, IRQ0	P55, IRQ5	P41, PWM2, TM11O	VSS	P40, PWM1, TM0IO	
PH5, AN13	PH3, AN11	PH4, AN12	PH1, AN9	PH0, AN8	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P36, D30, SBT3	P42, PWM3, TM2IO	P37, D31, PWM0	VDDH	P35, D29, SBO3	
PI5, AN21	PI3, AN19	PH7, AN15	PH1, AN17	PI0, AN16	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P27, D23, SBO1	VSS	P31, D25, SBI2	P32, D26, SBO2	P30, D24, SBT1	
AVSS	PI7, AN23	PH6, AN14	PI4, AN20	PI6, AN22	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P21, D17, SBOB	P24, D20, SBO0	P23, D19, SBI0	P22, D18, SBTB	P26, D22, SBI1	
VSS	PM1, CS1	PI2, AN18	VDDDB	P70, AN24	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P12, D10	P16, D14	N.C.*1 (VSS)	P20, D16, SBIB	VSS	
PM3, CS3	PN0, WET, SDQM0	PM0, CS0	PM4, CS4	VSS	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P10, D8	VDDH	P17, D15	P13, D11	N.C.*2 (VDDF)	
PN2, SYSCLK	VSS	PM5, RWSEL	PN4, DK	VDD	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	P02, D2	VSS	P15, D13	P07, D7	P11, D9	
PO0, ADM0, A0	VDD	PM2, CS2	PN5, AS	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	N.D.	VSS	P00, D0	P06, D6	P03, D3	P05, D5	
VDDDB	PO5, ADM5, A5	PN1, WET, SDQM1	PO1, ADM1, A1	VSS	N.D.	PVSS	MMOD1	VSS	PK3, TM33IO	PL2, TM5IO	PR1, A20, KI1	PR7, KI7, PWM5	N.D.	PT1, SBO9	VOUT	P04, D4	P14, D12	P01, D1	
PO3, ADM3, A3	PO2, ADM2, A2	PN3, RE	PO7, ADM7, A7	VSS	TRST	VDDH	CKSEL	VDD	PK4, TM34IO	PL3, TM6IO	PR2, A21, KI2, SWE	PS0, SBI4	VSS	PS5, SBT5	PS3, SBI5	VDDH	VOUT	electrode (pin) none	
PO6, ADM6, A6	VDDDB	PP2, ADM10, A10	PO4, ADM4, A4	PP4, ADM12, A12	PK1, TM31IO	PK5, TM35IO	PK7, TM37IO	PK0, TM30IO	PL1, TM4IO	PL4, TM7IO	PQ0, A16	PQ2, A18	VDDH	PR4, A23, KI4, SDCLKO	PU0, WE2, SCAS	NMIRQ	VDDH	VSS	
		PP6, ADM14, A14	PI0, EXMOD0	PP3, ADM11, A11	PP7, ADM15, A15	PI1, EXMOD1	FRQS	PK2, TM32IO	PK6, TM36IO	PL5, TM6IO	PR0, A19, KI0	PWM6	PS2, SBT4	PT0, SBI9	PS1, SBO4	LON			
N.D.		PP0, ADM8, A8	PP1, ADM9, A9	PP5, ADM13, A13	PVDD	MMOD0	OSCO	OSCI	PL0, TM3IO	VSS	PQ1, A17	PR3, A22, KI3, SCKE	PR6, A25, KI6	PS4, SBO5	PT2, SBT9	PU1, WE3, SRAS	N.D.		
	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1

MLGA344-C-1313 \*Lead-free

- \* N.D.has an electrode (pin) but N.C. is not guaranteed. Please design so as not to cause short circuit with other wiring on the user board.
- \* Each of VDDH, VDD, VDDDB, VDDF, VDD2, and VSS has multiple electrodes (pins). Connect the same electrode names to the same power supply.
- \*1: Connect the J3, R6, and R12 pins to the VSS for the MN103SF33N.
- \*2: Connect the H1 and T1 pins to the VDDF power for the MN103SF33N.

## SupportTool

■ <b>In-circuit Emulator</b>	PX-ICE103S33	Not applicable to MLGA344-C-1313.
■ <b>On-board Development Tools</b>	PX-ODB103S-O	
■ <b>Flash Memory Built-in Type</b>	Type	MN103SF33N (under development)
	Command ROM (× 64-bit)	512 K-byte
	Data RAM (× 32-bit)	24 K-byte
	Minimum instruction execution time	24.3 ns (at 2.3 V to 2.7 V, 41 MHz)
	Package	MLGA344-C-1313 *Lead-free



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